19-1834; Rev 1; 5/01



# W-CDMA LNA/Mixer ICs

# **General Description**

The MAX2387/MAX2388/MAX2389 low-noise amplifier (LNA), downconverter mixers designed for W-CDMA applications, are ideal for ARIB (Japan) and ETSI-UMTS (Europe) based systems. The MAX2387/MAX2388/MAX2389 feature ultra-low current consumption and exceptionally low noise figures in ultra-small packages.

The MAX2387/MAX2388 include an LNA, a downconverter mixer, and a local-oscillator (LO) buffer. The MAX2389 has an LNA and mixer, but minimizes current consumption by omitting the LO buffer. For all devices, the LNA and downconverter mixers are optimized for the 2110MHz to 2170MHz band. All devices feature a high-gain mode and a low-gain mode of LNA operation. The MAX2387 has a 32dB gain step, and the MAX2388/MAX2389 have an 18dB gain step. All ICs include a shutdown mode, powering down the IC during the front-end receiver's idle periods.

The mixer 3rd-order nonlinearity performance is set using an external biasing resistor. For the MAX2387/ MAX2388, mixer performance is optimized for a -10dBm typical drive at the LO buffer input port. The MAX2389 mixer performance is optimized for a -4dBm typical drive at the LO input port. The LO port for all versions is configurable for either single-ended or differential operation.

These devices operate from a +2.7V to +3.3V single supply and are available in ultra-small ( $3mm \times 3mm$ ) 12-pin leadless packages (QFN).

## **Applications**

Japanese 3rd-Generation W-CDMA Cellular Phones

Dual-Mode W-CDMA/GSM Cellular Phones

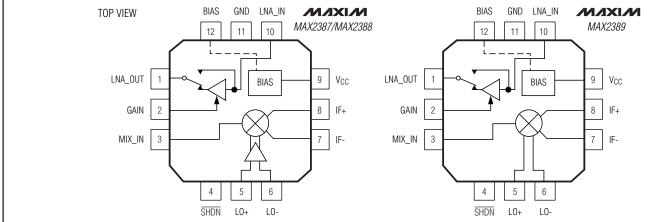
#### Features

- Ultra-Low Current Consumption: 10.7mA (MAX2387), 9.9mA (MAX2388), and 7.9mA (MAX2389)
- ♦ +2.7V to +3.3V Single-Supply Operation
- Mixer NF: 7dB SSB
- Cascaded Noise Figure: 2.3dB
- LNA Low-Gain Mode: 32dB Gain Step (MAX2387) or 18dB Gain Step (MAX2388/MAX2389)
- Mixer IIP3: 6dBm
- < 1µA Shutdown Current</p>
- ♦ Ultra-Small (3mm × 3mm) 12-Pin QFN Package

## **Ordering Information**

PART	TEMP. RANGE	PIN-PACKAGE
MAX2387EGC	-40°C to +85°C	12 QFN
MAX2388EGC	-40°C to +85°C	12 QFN
MAX2389EGC	-40°C to +85°C	12 QFN





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Maxim Integrated Products 1

For pricing, delivery, and ordering information, please contact Maxim/Dallas Direct! at 1-888-629-4642, or visit Maxim's website at www.maxim-ic.com.

#### **ABSOLUTE MAXIMUM RATINGS**

V <sub>CC</sub> to GND	0.3V to +4.3V
SHDN, GAIN to GND	-0.3V to (V <sub>CC</sub> + 0.3V)
AC Signals	+1V peak
Digital Input Current	±10mA
Continuous Power Dissipation ( $T_A = +70^{\circ}C$	
12-Pin QFN (derate 11.9mW/°C above T	$A = +70^{\circ}C)952mW$

Operating Temperature Range	40°C to +85°C
Junction Temperature	+150°C
Storage Temperature Range	65°C to +150°C
Soldering Temperature (10s)	+300°C

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

## DC ELECTRICAL CHARACTERISTICS

 $(V_{CC} = +2.7V \text{ to } +3.3V, \overline{SHDN} = \text{high}, R_{BIAS} = 24k\Omega$ , no input AC signals,  $T_A = -40^{\circ}\text{C}$  to  $+85^{\circ}\text{C}$ . Typical values are at  $V_{CC} = +2.7V$ ,  $T_A = +25^{\circ}\text{C}$ , unless otherwise noted.)

PARAMETER	SYMBOL	CONDITION	S	MIN	ТҮР	MAX	UNITS
			MAX2387		10.7	12.4	
		High-gain mode	MAX2388		9.9	11.7	
Operating Supply Current	lee		MAX2389		7.9	9.3	mA
Operating Supply Current	Icc		MAX2387		7.2	8.7	ША
		Low-gain mode	MAX2388		6.7	8.1	
			MAX2389		4.7	5.7	
Shutdown Supply Current	ICC	$\overline{\text{SHDN}} = \text{low}$			0.2	1.0	μA
Digital Input Logic High	VIH			2.0			V
Digital Input Logic Low	VIL					0.6	V
Input Logic High Current	IIН	$V_{IN} = V_{IH}$				1	μA
Input Logic Low Current	ΙL	$V_{IN} = V_{IL}$		-20			μA

### AC ELECTRICAL CHARACTERISTICS

 $(MAX238\_EV \text{ kit, } V_{CC} = 2.7V, \overline{SHDN} = \text{high, } f_{RF\_IN} = f_{LNA\_IN} = 2140 \text{MHz}, f_{LO} = 2330 \text{MHz} (f_{IF} = 190 \text{MHz}). \text{ Mixer, LNA, and LO input ports are driven with } 50\Omega \text{ sources. } R_{BIAS} = 24 \text{k}\Omega \pm 1\%, P_{LO} = -10 \text{dBm} (MAX2387/MAX2388), P_{LO} = -4 \text{dBm} (MAX2389), P_{RF} = -30 \text{dBm}. \text{ Typical values are at } V_{CC} = +2.7V, T_A = +25^{\circ}\text{C}, \text{ unless otherwise noted.}$ 

PARAMETER	SYMBOL	CONDITIONS	MIN	ΤΥΡ	MAX	UNITS
LNA PERFORMANCE: LOW-GAI	N MODE (GA	IN = HIGH)				
RF Frequency Range (Note 1)	f <sub>RF</sub>		2110		2170	MHz
Gain	C	$T_A = +25^{\circ}C$	13.5	15	16.5	dB
	G <sub>LNA</sub>	$T_A = -40^{\circ}C \text{ to } +85^{\circ}C \text{ (Note 2)}$	12.9		17.0	uБ



## AC ELECTRICAL CHARACTERISTICS (continued)

(MAX238\_EV kit, V<sub>CC</sub> = 2.7V,  $\overline{SHDN}$  = high, f<sub>RF\_IN</sub> = f<sub>LNA\_IN</sub> = 2140MHz, f<sub>LO</sub> = 2330MHz (f<sub>IF</sub> = 190MHz). Mixer, LNA, and LO input ports are driven with 50 $\Omega$  sources. R<sub>BIAS</sub> = 24k $\Omega$  ±1%, P<sub>LO</sub> = -10dBm (MAX2387/MAX2388), P<sub>LO</sub> = -4dBm (MAX2389), P<sub>RF</sub> = -30dBm. Typical values are at V<sub>CC</sub> = +2.7V, T<sub>A</sub> = +25°C, unless otherwise noted.)

PARAMETER	SYMBOL	CONDITIONS		MIN	ТҮР	MAX	UNITS	
Noise Figure (Notes 1, 3)	NF <sub>LNA</sub>	$T_A = +25^{\circ}C$			1.7	2.2	dB	
3 <sup>rd</sup> -Order Input Intercept Point (Note 4)	IIP3 <sub>LNA</sub>	$T_A = -40^{\circ}C \text{ to } +85^{\circ}C \text{ (Note 2)}$	I		4.2		dBm	
Input -1dB Compression Point (Note 1)	IP-1dB			-19	-13		dBm	
LNA PERFORMANCE: LOW-GA	IN MODE (GA	IN = LOW)						
			MAX2387	-18.5	-16.5	-14.5		
Gain		$T_A = +25^{\circ}C$	MAX2388/ MAX2389	-4.7	-2.8	-0.9	-10	
	G <sub>LNA</sub>	-	MAX2387	-10.5		-14	dB	
		T <sub>A</sub> = -40°C to +85°C (Note 2)	MAX2388/ MAX2389	5.4		-0.7	1	
			MAX2387		19.2	21.3		
Noise Figure (Notes 1, 3)	NF <sub>LNA</sub>		MAX2388/ MAX2389		6.5	8.4	dB	
			MAX2387		1			
3rd-Order Input Intercept Point (Note 5)	IIP3 <sub>LNA</sub>		MAX2388/ MAX2389		3.4		dBm	
			MAX2387		-9.9			
Input -1dB Compression Point	IP-1dB		MAX2388/ MAX2389		-7.7		dBm	
MIXER PERFORMANCE (GAIN =	= HIGH)			•				
RF Frequency Range (Note 1)	f <sub>RF</sub>			2110		2170	MHz	
LO Frequency Range (Note 1)	fLO			2250		2600	MHz	
IF Frequency Range (Note 1)	fıF			150		400	MHz	
Power Conversion Gain	G <sub>MXR</sub>	$T_A = +25^{\circ}C$		8.5	10	11.5	dB	
		$T_A = -40^{\circ}C \text{ to } +85^{\circ}C \text{ (Note 2)}$		7.5		12.5		
			MAX2387		7.2	8.8		
Noise Figure (SSB) (Note 1)	NF <sub>MXR</sub>	$T_A = +25^{\circ}C$	MAX2388		6.8	8.2	dB	
			MAX2389		7.3	9.5		

## AC ELECTRICAL CHARACTERISTICS (continued)

(MAX238\_EV kit, V<sub>CC</sub> = 2.7V,  $\overline{SHDN}$  = high, f<sub>RF\_IN</sub> = f<sub>LNA\_IN</sub> = 2140MHz, f<sub>LO</sub> = 2330MHz (f<sub>IF</sub> = 190MHz). Mixer, LNA, and LO input ports are driven with 50 $\Omega$  sources. R<sub>BIAS</sub> = 24k $\Omega$  ±1%, P<sub>LO</sub> = -10dBm (MAX2387/MAX2388), P<sub>LO</sub> = -4dBm (MAX2389), P<sub>RF</sub> = -30dBm. Typical values are at V<sub>CC</sub> = +2.7V, T<sub>A</sub> = +25°C, unless otherwise noted.)

PARAMETER	SYMBOL	CONDITIONS		MIN	TYP	МАХ	UNITS	
			MAX2387		6			
3rd-Order Input Intercept Point (Notes 1, 3)	IIP3 <sub>MXR</sub>		MAX2388		6		dBm	
			MAX2389		5			
			MAX2387	-13.9	-10			
Input -1dB Compression Point (Note 1)	IP-1dB,MXR	$T_A = -40^{\circ}C \text{ to } +85^{\circ}C$	MAX2388	-16.3	-10.5		dBm	
			MAX2389	-15.4	-10.5			
MIXER PERFORMANCE (GAIN =	LOW)							
Power Conversion Gain (Note 1)	Guiro	$T_A = +25^{\circ}C$		7.5	9.0	10.5	dB	
Fower Conversion Gain (Note 1)	G <sub>MXR</sub>	$T_A = -40^{\circ}C \text{ to } +85^{\circ}C$		6.5		12.0	uв	
			MAX2387		6.9	8.4		
Noise Figure (SSB) (Note 1)	NF <sub>MXR</sub>	$T_A = +25^{\circ}C$	MAX2388		6.1	7.4	dB	
			MAX2389		6.6	8.8		
Ord Onders largest latence and Deint			MAX2387		0.7			
3rd-Order Input Intercept Point (Note 4)	IIP3 <sub>MXR</sub>	$T_A = +25^{\circ}C$	MAX2388		0.2		dBm	
			MAX2389		1.3			
			MAX2387	-15.0	-10.7			
Input -1dB Compression Point (Note 1)	IP-1dB,MXR	$T_A = -40^{\circ}C \text{ to } +85^{\circ}C$	MAX2388	-18.2	-11.3		dBm	
			MAX2389	-17.8	-11.9			

Note 1: Guaranteed by design and characterization.

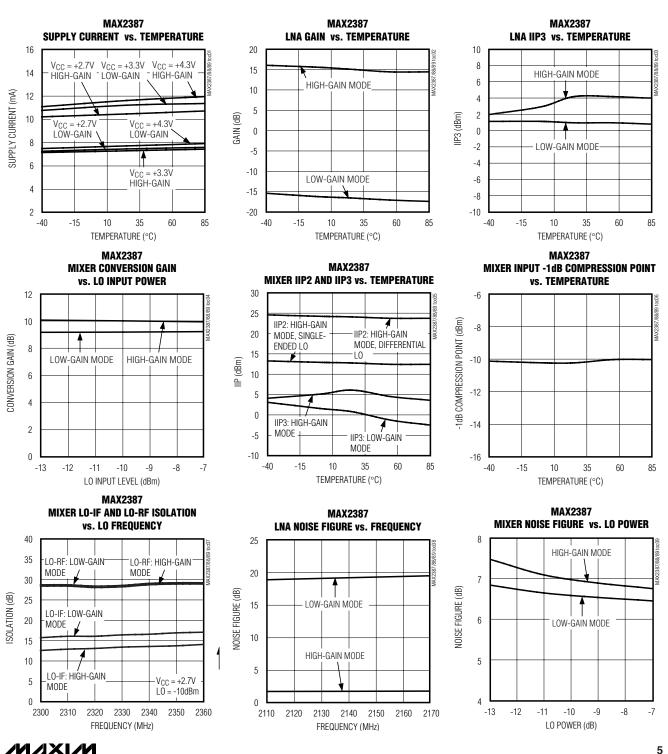
Note 2: MIN guaranteed by production test, MAX guaranteed by design and characterization.

Note 3: Includes input matching circuit loss.

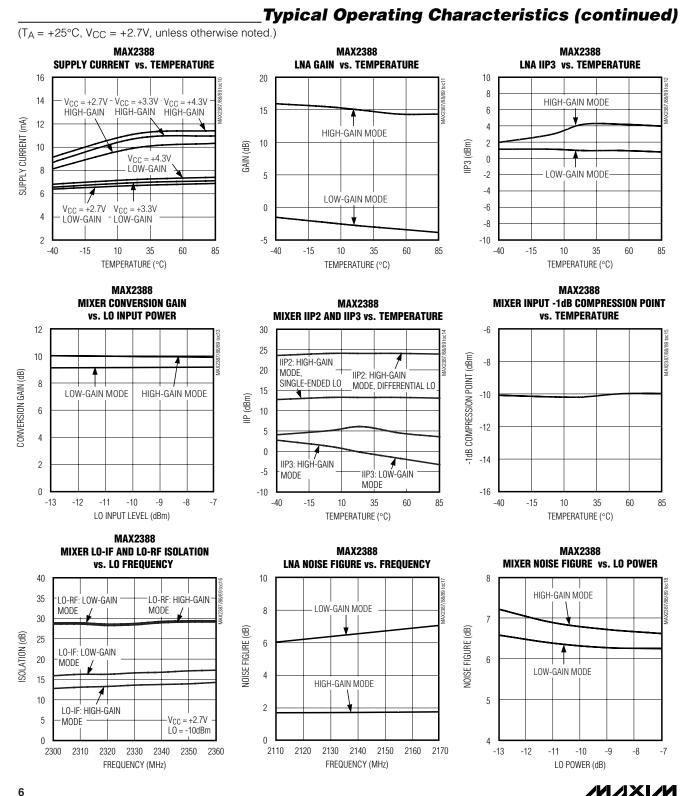
**Note 4:**  $f_{IN1} = 2140MHz$ ,  $f_{IN2} = 2141MHz$ ,  $P_{IN} = -30dBm$  per tone.

Note 5:  $f_{IN1} = 2140MHz$ ,  $f_{IN2} = 2141MHz$ ,  $P_{IN} = -25dBm$  per tone.

#### **Typical Operating Characteristics**

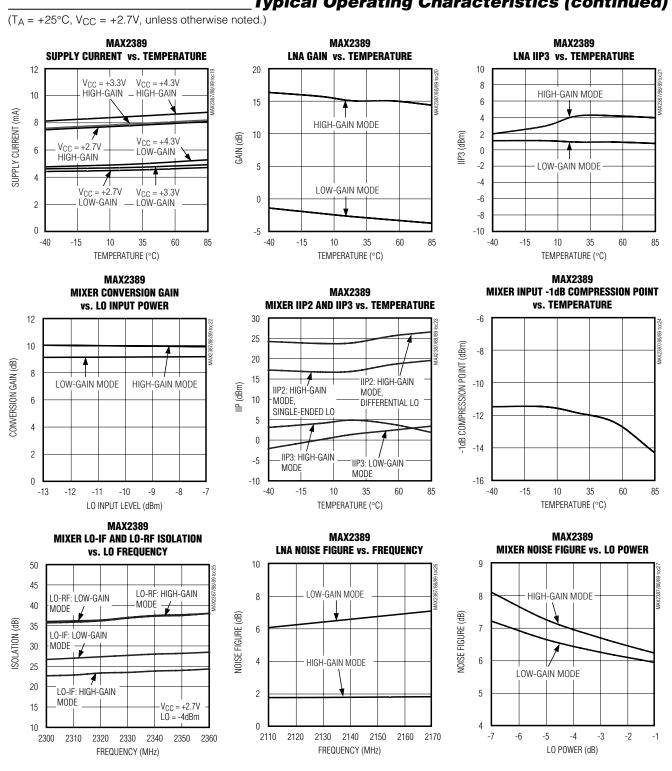


 $(T_A = +25^{\circ}C, V_{CC} = +2.7V, unless otherwise noted.)$ 



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MAX2387/MAX2388/MAX2389



## Typical Operating Characteristics (continued)

MAX2387/MAX2388/MAX2389

## **Pin Description**

PIN	NAME	FUNCTION
1	LNA_OUT	RF Output Port for LNA. Requires external matching.
2	GAIN	LNA/Mixer Gain Control Input
3	MIX_IN	RF Input Port for Mixer. Internally matched to $50\Omega$ .
4	SHDN	Shutdown Input. Drive low to enable shutdown mode. Drive high or connect to $V_{CC}$ for normal operation.
5	LO+	Noninverting LO Input for LO Buffer (MAX2387/MAX2388) or Mixer (MAX2389). Differential input impedance is $200\Omega$ . AC-couple to GND when the LO is driven single-endedly.
6	LO-	Inverting LO Input for LO Buffer (MAX2387/MAX2388) or Mixer (MAX2389). Differential input impedance is 200 $\Omega$ .
7	IF-	Inverting Mixer's IF Open-Collector Output
8	IF+	Noninverting Mixer's IF Open-Collector Output
9	Vcc	Supply Voltage (+2.7V to +3.3V). Capacitively bypass to GND near the IC.
10	LNA_IN	RF Input Port for LNA. Requires external matching.
11	GND	Ground
12	BIAS	LNA/Mixer Bias Pin. For nominal bias, connect 24k $\Omega$ ±1% resistor to GND.

### **Detailed Description**

The MAX2387/MAX2388/MAX2389 include an LNA and downconverter mixer. These devices feature a shutdown mode to power down the IC during the frontend receiver's idle periods. Each IC operates from a +2.7V to +3.3V single supply and is housed in a 12-pin ultra-small QFN (3mm × 3mm) leadless package.

The MAX2387/MAX2388/MAX2389 are fabricated using an advanced high-frequency silicon germanium process. The LNA and mixer NF and IIP3 have been optimized to provide excellent RF performance in the 2110MHz to 2170MHz band, while drawing minimal current.

For the MAX2387/MAX2388, the mixer's performance is optimized for a -10dBm typical drive at the LO buffer input port. The MAX2389's mixer performance is optimized for a -4dBm typical drive at the LO input port. The LO port for all versions can be driven either singleended or differentially.

#### LNA High/Low-Gain Mode

These devices offer two modes of operation for the LNA: high-gain mode and low-gain mode, selectable with a GAIN select pin. The MAX2387 has a gain of 15dB in high-gain mode and -16.6dB in low-gain mode. The MAX2388/MAX2389 have a gain of 15dB in high-gain mode and -2.8dB in low-gain mode. Matching LNA in high-gain mode will ensure matching in low-gain mode.

#### **Downconverter Mixer**

The receive mixer is a wideband, single-balanced design with exceptional noise figure and linearity. The LO input frequency range is 2330MHz to 2360MHz and the RF input frequency range is 2110MHz to 2170MHz. The mixer is internally matched to  $50\Omega$ , thus eliminating any external matching components.

#### **LO Input Buffers**

The MAX2387/MAX2388 feature open-collector LO buffers to increase isolation between the LO and the rest of the system. The MAX2389 offers a lower current consumption for applications that do not require an LO buffer.

#### **RF** Inputs

The MIX\_IN input is typically connected to the LNA output through an off-chip filter providing image rejection and out-of-band interferers filtering. The LNA input and output require an external matching network to  $50\Omega$ . Note that the mixer input is internally matched to  $50\Omega$ . See Figure 1, *Typical Application Circuits* for 2.14GHz.

#### **LO Inputs**

The LO+ and LO- pins are internally terminated with  $100\Omega$  resistors. AC-couple the local-oscillator signal to these pins. If a single-ended LO source is used, connect LO+ to ground using an AC-coupling capacitor.

#### **IF Output Port**

The mixer output appears on the differential  $I\bar{F}$ + and IFpins. These open-collector outputs require an external inductor to V<sub>CC</sub> for DC biasing. This port typically requires a matching network for coupling to an external IF filter. Figures 1 and 2 show examples of differential and single-ended IF port connections.

#### **Applications Information**

#### Layout

A properly designed PC board is essential to any RF/microwave circuit. Keep RF signal lines as short as possible to minimize losses and radiation. Always use controlled impedance lines on all high-frequency inputs and outputs and use low-inductance connections to ground on all GND pins. At the mixer outputs, keep the differential lines together and of the same length to ensure signal balance. For the best gain and noise performance, use highquality components for the LNA input matching circuit, and solder the slug evenly to the board ground plane.

For the power supplies, a star topology works well to isolate between different sections of the device. Each V<sub>CC</sub> node has its own path to a central V<sub>CC</sub>. Place decoupling capacitors that provide low impedance at the RF frequency of interest close to all V<sub>CC</sub> connections. The central V<sub>CC</sub> should have a large decoupling capacitor as well. (Use MAX2387/MAX2388/MAX2389 EV kit as an example.)

#### **Chip Information**

TRANSISTOR COUNT: 208

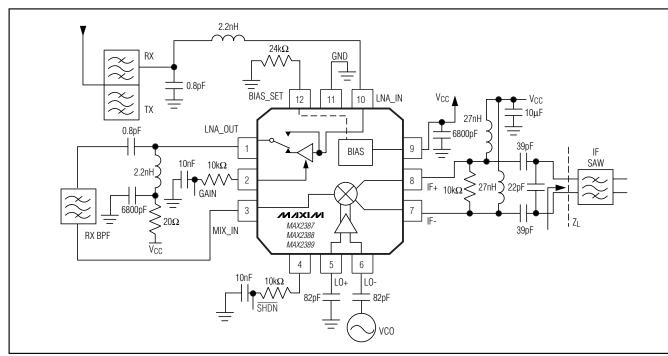


Figure 1. MAX2387/MAX2388/MAX2389 Differential IF Load; Single-Ended VCO



## **Typical Application Circuits**



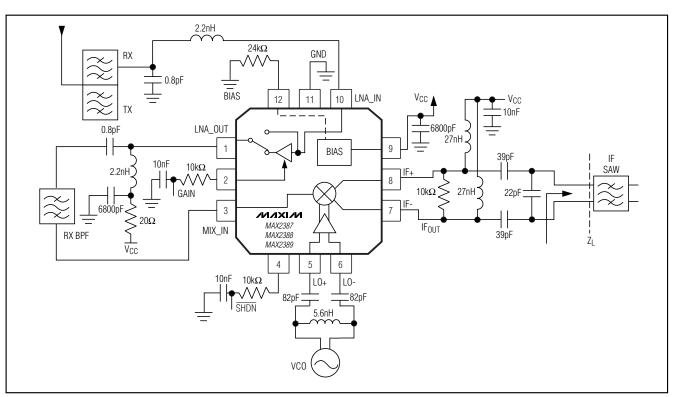


Figure 2. MAX2387/MAX2388/MAX2389 Differential IF Load; Differential VCO

W-CDMA	.NA/Mixer	ICs
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S-PARAMETERS	LNA (S	611)	LNA (	S21)	LNA (S	612)	LNA (S	22)
FREQUENCY (MHZ)	MAGNITUDE	PHASE	MAGNITUDE	PHASE	MAGNITUDE	PHASE	MAGNITUDE	PHASE
600	0.83287	-41.655	5.2176	146.82	0.020023	79.051	0.92461	-15.535
700	0.81889	-43.792	5.0791	145.33	0.021153	78.88	0.9171	-16.23
800	0.80364	-46.486	4.9464	143.26	0.022406	78.412	0.91098	-17.187
900	0.78522	-49.489	4.7767	141.09	0.023962	79.181	0.90108	-18.177
1000	0.76638	-53.118	4.6109	138.2	0.025913	78.989	0.8914	-19.536
1100	0.74542	-56.424	4.4363	135.68	0.027189	79.621	0.87913	-20.759
1200	0.72614	-59.477	4.2861	133.2	0.028484	79.666	0.86957	-22.045
1300	0.70338	-62.232	4.1209	130.93	0.030015	80.686	0.85623	-23.156
1400	0.68291	-64.933	4.0146	128.4	0.030979	81.41	0.84504	-24.46
1500	0.66114	-67.298	3.8951	126.82	0.032236	82.856	0.83313	-25.525
1600	0.63958	-69.782	3.7818	124.53	0.033056	83.763	0.82095	-26.882
1700	0.61641	-72.041	3.6761	122.88	0.03398	85.56	0.80875	-28.147
1800	0.59303	-74.571	3.5823	120.51	0.035009	86.377	0.79497	-29.825
1900	0.56989	-76.974	3.5198	118.87	0.036332	88.572	0.78338	-31.503
2000	0.54509	-79.651	3.4376	116.77	0.036887	89.686	0.76891	-33.44
2100	0.52084	-82.452	3.3691	115.17	0.038318	91.409	0.75735	-35.559
2200	0.49554	-85.891	3.2858	112.47	0.039355	93.409	0.74365	-38.175
2300	0.47232	-89.473	3.2544	110.28	0.040817	94.973	0.73415	-41.034
2400	0.44892	-93.529	3.195	108.05	0.042049	97.086	0.72262	-44.165
2500	0.42766	-98.164	3.1347	105.62	0.043438	98.58	0.71335	-47.828
2600	0.40833	-103.42	3.06	102.94	0.044844	100.14	0.70474	-51.733
2700	0.39421	-109.16	2.9818	100.13	0.046899	101.7	0.70067	-56.04
2800	0.38321	-115.32	2.9149	96.964	0.048389	103.31	0.69795	-60.397
2900	0.37608	-121.52	2.821	94.462	0.049426	104.62	0.69514	-64.899
3000	0.37573	-128.03	2.7086	91.479	0.05079	106.39	0.69504	-69.425
3100	0.38123	-134.23	2.5802	88.528	0.051657	108.22	0.69915	-73.798
3200	0.39208	-139.73	2.4696	85.584	0.053915	110.43	0.70504	-77.625
3300	0.40626	-144.57	2.3296	83.264	0.055483	113.29	0.71095	-81.166
3400	0.42512	-148.8	2.2157	80.95	0.05783	115.29	0.71819	-84.4
3500	0.44708	-152.13	2.0519	79.588	0.060614	118.09	0.72516	-87.06
3600	0.47302	-154.7	1.9382	77.337	0.065129	119.23	0.73416	-89.168
3700	0.49849	-156.57	1.8048	76.594	0.069104	120.99	0.73997	-90.676

#### Table 1. LNA Input/Output S-Parameters (VCC = +2.7V, High-Gain Mode)

#### **Package Information**

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For the latest package outline information, go to **www.maxim-ic.com/packages**.

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			Part Nu	imber Tal	ble		
Notes:							
MAX2388 fu 2. Other option 3. Didn't Find V one busines 4. Part numbe full data she	ull data sheet ns and links f What You Nee ss day. er suffixes: T eet or Part Na ckages have v	(PDF, 19 for purch ed? Ask or T&R = aming Co	92kB). asing parts are our applications = tape and reel; onventions.	listed at: htt engineers. E ; + = RoHS/Id	p://www.n xpert assis ead-free; #	naxim-ic.com/s stance in finding # = RoHS/lead-	or download the ales. g parts, usually within exempt. More: See ich variation the
Part Number	Free Sample	Buy Direct	Package: TY DR	PE PINS SIZ		Temp	RoHS/Lead-Free? Materials Analysis
MAX2388EVKIT							
MAAZJOOL VALI							RoHS/Lead-Free: No
			QFN;12 pin;3x Dwg: 21-0102 Use pkgcode/v	G (PDF)	233-1*	-40C to +85C	RoHS/Lead-Free: No RoHS/Lead-Free: No Materials Analysis
MAX2388EGC			Dwg: 21-0102	G (PDF) variation: G12 c3x0.9mm G (PDF)			RoHS/Lead-Free: No
MAX2388EGC MAX2388EGC-T MAX2388EGC+			Dwg: 21-0102 Use pkgcode/v QFN;12 pin;3x Dwg: 21-0102	G (PDF) variation: G12 (3x0.9mm G (PDF) variation: G12 (3x0.9mm G (PDF)	233-1*	-40C to +85C	RoHS/Lead-Free: No Materials Analysis RoHS/Lead-Free: No Materials Analysis
MAX2388EGC MAX2388EGC-T MAX2388EGC+			Dwg: 21-0102 Use pkgcode/v QFN;12 pin;3x Dwg: 21-0102 Use pkgcode/v QFN;12 pin;3x Dwg: 21-0102	G (PDF) variation: G12 (3x0.9mm G (PDF) variation: G12 (3x0.9mm G (PDF) variation: G12 (3x0.9mm G (PDF)	233-1 <b>*</b> 233+1 <b>*</b>	-40C to +85C -40C to +85C	RoHS/Lead-Free: No Materials Analysis RoHS/Lead-Free: No Materials Analysis RoHS/Lead-Free: Yes Materials Analysis
MAX2388EGC MAX2388EGC-T			Dwg: 21-0102 Use pkgcode/v QFN;12 pin;3x Dwg: 21-0102 Use pkgcode/v QFN;12 pin;3x Dwg: 21-0102 Use pkgcode/v QFN;12 pin;3x Dwg: 21-0102	G (PDF) variation: G12 (3x0.9mm G (PDF) variation: G12 (3x0.9mm G (PDF) variation: G12 (3x0.9mm G (PDF) variation: G12 pin; 3X3X0.8m I (PDF)	233-1* 233+1* 233+1* nm	-40C to +85C -40C to +85C -40C to +85C	RoHS/Lead-Free: No Materials Analysis RoHS/Lead-Free: No Materials Analysis RoHS/Lead-Free: Yes Materials Analysis RoHS/Lead-Free: Yes

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